TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

TC74HC138AP, TC74HC138AF, TC74HC138AFN

3-TO-8 LINE DECODER

The TC74HC138A is a high speed CMOS 3-to-8 DECODER fabricated with silicon gate C2MOS technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

When the device is enabled, 3 Binary Select inputs (A, B and C) determine which one of the outputs $(\overline{Y}0 - \overline{Y}7)$ will go low.

When enable input G1 is held low or either $\overline{G}2A$ or $\overline{G}2B$ is held high, decoding function is inhibited and all outputs go high.

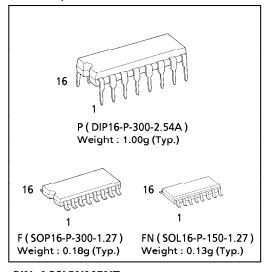
 $\overline{G1}$, $\overline{G}2A$, and $\overline{G}2B$ inputs are provided to ease cascade connection and for use as an address decoder for memory systems.

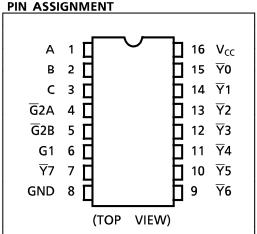
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

FEATURES:

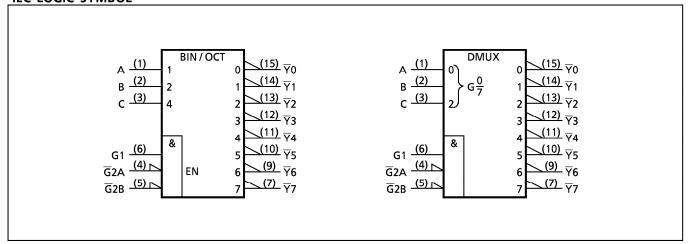
- High Speed······ $t_{od} = 16ns(typ.)$ at $V_{CC} = 5V$
- High Noise Immunity $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (Min.)
- Output Drive Capability 10 LSTTL Loads
- Symmetrical Output Impedance··· | I_{OH} | = I_{OL} = 4mA(Min.)
- \bullet Balanced Propagation Delays….. $t_{pLH}{\simeq}t_{pHL}$
- Wide Operating Voltage Range···· V_{CC} (opr.) = 2V~6V
- Pin and Function Compatible with 74LS138

(Note) The JEDEC SOP (FN) is not available in Japan.





IEC LOGIC SYMBOL



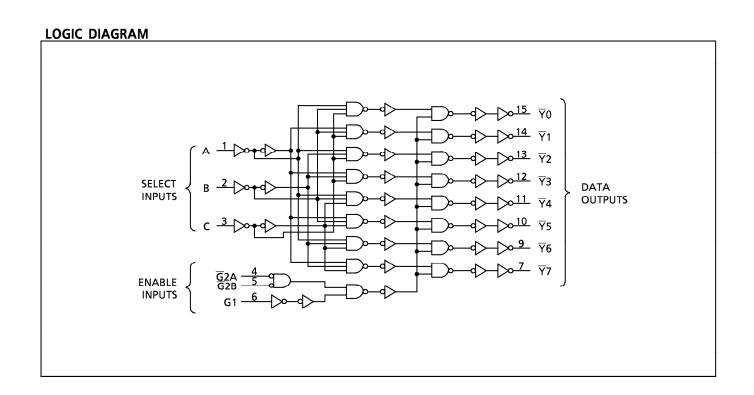
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TRUTH TABLE

	INPUTS						OUTPUTS									
ENABLE		SELECT		₹0	<u>7</u> 1	_ <u>∀</u> 2	<u>7</u> 3		<u>7</u> 5	<u>7</u> 6		SELECTED OUTPUT				
G1	G ₂ A	G ₂ B	С	В	Α	'0	' '	12	13	14	13	10	'			
L	Х	Х	Х	Х	Х	Н	Н	Н	Н	Н	Н	Н	Н	NONE		
Х	Н	Х	Х	Х	Х	Н	Н	Н	Н	Н	Н	Н	Н	NONE		
Х	Х	Н	Х	Х	Х	Н	Н	Н	Н	Н	Н	Н	Н	NONE		
Н	L	L	L	L	L	L	Н	Н	Н	Н	Н	Н	Н	<u></u> 70		
Н	L	L	L	L	Н	Н	L	Н	Н	Н	Н	Н	Н	<u>\(\bar{Y} \) 1</u>		
Н	L	L	L	Н	L	Н	Н	L	Н	Н	Н	Н	Н	<u>\(\bar{Y} 2 \) \)</u>		
Н	L	L	L	Н	Н	Н	Н	Н	L	Н	Н	Н	Н	<u>7</u> 3		
Н	L	L	Н	L	L	Н	Н	Н	Н	L	Н	Н	Н	<u>¥</u> 4		
Н	L	L	Н	L	Н	Н	Н	Н	Н	Н	L	Н	Н	<u> </u>		
Н	L	L	Н	Н	L	Н	Н	Н	Н	Н	Н	L	Н	<u> </u>		
Н	L	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	L	\ \ \overline{Y}7		

X : Don't Care



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ABSOLUTE MAXIMUM RATINGS

E			
PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage Range	V _{cc}	− 0.5 ~ 7	V
DC Input Voltage	VIN	$-0.5 \sim V_{CC} + 0.5$	V
DC Output Voltage	V _{OUT}	$-0.5 \sim V_{CC} + 0.5$	V
Input Diode Current	I _{IK}	± 20	mA
Output Diode Current	I _{OK}	± 20	mA
DC Output Current	I _{OUT}	± 25	mA
DC V _{CC} / Ground Current	I _{cc}	± 50	mA
Power Dissipation	P _D	500 (DIP)* / 180 (SOP)	mW
Storage Temperature	T _{stg}	−65~150	°C

^{*500}mW in the range of Ta = $-40^{\circ}\text{C} \sim 65^{\circ}\text{C}$. From Ta = 65°C to 85°C a derating factor of $-10\text{mW}/^{\circ}\text{C}$ shall be applied until 300mW.

RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage	V _{cc}	2~6	V
Input Voltage	V _{IN}	0~V _{cc}	V
Output Voltage	V _{OUT}	0~V _{CC}	٧
Operating Temperature	T _{opr}	−40~85	°C
Input Rise and Fall Time	t _r , t _f	$0 \sim 1000 \text{ (V}_{CC} = 2.0 \text{ V)}$ $0 \sim 500 \text{ (V}_{CC} = 4.5 \text{ V)}$ $0 \sim 400 \text{ (V}_{CC} = 6.0 \text{ V)}$	ns

DC ELECTRICAL CHARACTERISTICS

PARAMETER	CVIAROL	TEST CO	NDITION	V _{cc}	Ta = 25°C			$Ta = -40 \sim 85^{\circ}C$		UNIT
PARAIVIETER	SYMBOL	1EST CC	(V)	MIN.	TYP.	MAX.	MIN.	MAX.	UNIT	
High - Level Input Voltage	V _{IH}				1.50 3.15 4.20			1.50 3.15 4.20		v
Low - Level Input Voltage	VIL			2.0 4.5 6.0	1 1	- - -	0.50 1.35 1.80	_ _ _	0.50 1.35 1.80	v
High - Level Output Voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	$I_{OH} = -20\mu A$	2.0 4.5 6.0	1.9 4.4 5.9	2.0 4.5 6.0	_ _ _	1.9 4.4 5.9	_ _ _	v
Output Voltage			$I_{OH} = -4 \text{ mA}$ $I_{OH} = -5.2 \text{ mA}$	4.5 6.0	4.18 5.68	4.31 5.80	<u> </u>	4.13 5.63	_ _	
Low - Level Output Voltage	V _{OL}	V _{IN} =	I _{OL} = 20μΑ	2.0 4.5 6.0		0.0 0.0 0.0	0.1 0.1 0.1	_ _ _	0.1 0.1 0.1	V
Output Voltage		V _{IH} or V _{IL}	$I_{OL} = 4 mA$ $I_{OL} = 5.2 mA$	4.5 6.0	_	0.17 0.18	0.26 0.26	_	0.33 0.33	
Input Leakage Current	Leakage Current I_{1N} $V_{1N} = V_{CC}$ or GND		6.0	_	_	±0.1	_	± 1.0		
Quiescent Supply Current	I _{cc}	$V_{1N} = V_{C}$	c or GND	6.0	_	_	4.0	_	40.0	μA

AC ELECTRICAL CHARACTERISTICS ($C_L = 15pF$, $V_{CC} = 5V$, Ta = 25°C, Input $t_r = t_f = 6ns$)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Output Transition Time	t _{TLH}		_	4	8	
Propagation Delay Time (A, B, $C-\overline{Y}$)	t _{pLH} t _{pHL}		_	16	26	ns
Propagation Delay Time (G, $\overline{G} - \overline{Y}$)	t _{pLH} t _{pHL}		_	15	25	

AC ELECTRICAL CHARACTERISTICS ($C_L = 50pF$, Input $t_r = t_f = 6ns$)

PARAMETER	SYMBOL	TEST CONDITION		Ta = 25°C		•	$Ta = -40 \sim 85^{\circ}$		UNIT
PARAIVIETER	STIVIBUL	TEST CONDITION	V _{CC} (V)	MIN.	TYP.	MAX.	MIN.	MAX.	OIVIII
Output Transition Time	t _{TLH}		2.0 4.5	_	30 8	75 15	_	95 19	
Catput Hansition Hine	t _{THL}		6.0	_	7	13	_	16	
Propagation Delay Time (A, B, $C-\overline{Y}$)	t _{pLH} t _{pHL}		2.0 4.5 6.0		70 19 16	150 30 26		190 38 32	ns
Propagation Delay Time (G, $\overline{G} - \overline{Y}$)	t _{pLH} t _{pHL}		2.0 4.5 6.0	_ _ _	65 18 15	145 29 25	_ _ _	180 36 31	
Input Capacitance	C _{IN}		·	_	5	10	_	10	, r
Power Dissipation Capacitance	C _{PD} (1)			_	47	_	_	_	pF

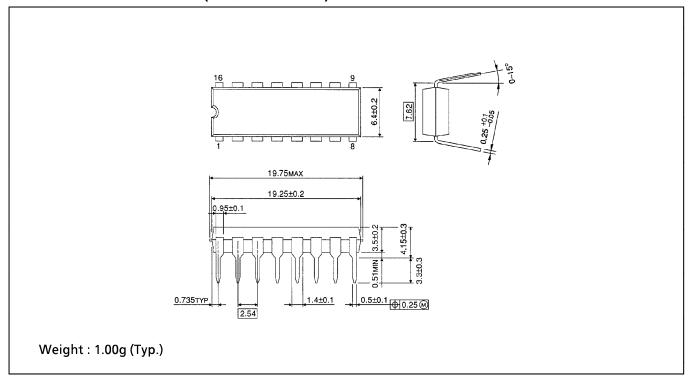
Note (1) C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 I_{CC} (opr) = $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$

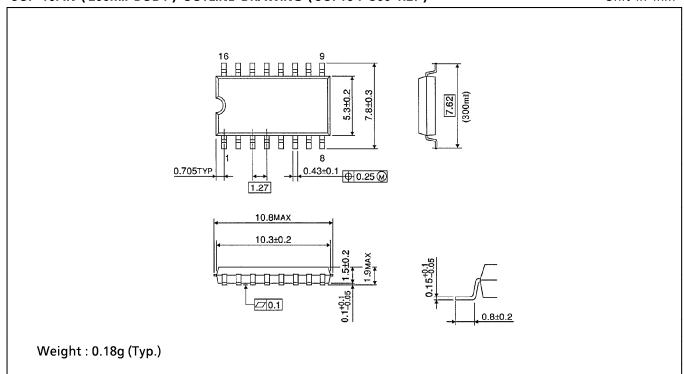
DIP 16PIN OUTLINE DRAWING (DIP16-P-300-2.54A)

Unit in mm



SOP 16PIN (200mil BODY) OUTLINE DRAWING (SOP16-P-300-1.27)

Unit in mm



SOP 16PIN (150mil BODY) OUTLINE DRAWING (SOL14-P-150 -1.27)

Unit in mm

